	COUNT	DESCRIPTION	TION OF REVISION		BY	CHKD	HKD DATE		COUN	T DESCRIP	DESCRIPTION OF REVISIONS		BY	CHKD	DA	TE
$\triangle$																
$\overline{\ }$																
APPLICABLE STANDARD																
RATING VOLTA					250 V AC TE			TEN	RATING PERATURE RANGE -30 °C TO +85 °C(N						1)	
CURRENT			г			2 A STRA			AGE PERATURE RANGE -10 °C TO +60 °C(N					NOTE	2)	
				SPECIFICATIONS												
ITEM TEST METHOD REC											REQ	UIREMEN	ITS		QT	AT
СО		JCTION														
GEN	NERAL E	XAMINATION								ACCORDI	ACCORDING TO DRAWING.					$\times$
MAF	RKING		CONFIRMED VISUALLY.												×	×
		C CHARACT														
CONTACT RESISTANCE			100 mA (DC OR 1000 Hz).							30 mΩ MA	30 mΩ MAX.					
INSULATION DESIGNANCE			500 V DC.							1000 ΜΩ Ι	MIN.				$ \times $	_
RESISTANCE VOLTAGE PROOF			650 V AC FOR 1 min.							NO FLASI	HOVER	OR BREAK	OOWN		$+_{\times}$	
		ICAL CHARA												1^	$\dashv$	
			50 TIMES INSERTIONS AND EXTRACTIONS.							② NO DA	① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					_
VIB	RATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.							1 μs.	① NO ELECTRICAL DISCONTINUITY OF					_
SHOCK			490 m/s <sup>2</sup> DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.								② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					
		MENTAL CH														
RAPID CHANGE OF TEMPERATURE			TEMPERATURE $-55 \rightarrow 5$ TO $35 \rightarrow +85 \rightarrow 5$ TO $35 ^{\circ}$ C TIME $30 \rightarrow 5$ TO $15 \rightarrow 30 \rightarrow 5$ TO 15min UNDER 5 CYCLES.							1 ② INSUL MIN. ③ NO DA	<ul> <li>② INSULATION RESISTANCE:1000 MΩ</li> <li>MIN.</li> <li>③ NO DAMAGE, CRACK OR LOOSENESS</li> </ul>					_
DAMP HEAT			EXPOSED AT 40±2 °C, 90 TO 95 %, 96 h.							OF PARTS.  ① CONTACT RESISTANCE: 30 mΩ MAX.						
(STEADY STATE)			ZN 3325711 40-2 3, 30 10 30 70, 30 11							② INSUL MIN.	② INSULATION RESISTANCE: 500 MΩ					_
										3 NO DA		, CRACK OR	LOOS	ENESS		
RESISTANCE TO SOLDERING HEAT			[RECOMMENDED TEMPERATURE PROFILE ] SOLDER TEMPERATURE, 260 ± 3℃, FOR IMMERSION ,DURATION ,10 s. [RECOMMENDED MANUAL SOLDERING CONDITION] SOLDERING IRON TEMPERATURE: 290 ± 10℃ FOR WITHIN 3 s. NO STRENGTH ON CONTACT. NO STRENGTH ON							EXCESSI	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.					
COLDEDARIUTY			CONTAC	T 001	DED TE	MOEDATI	DE	245%	S A NEW LI	A NEW UNIFORM COATING OF SOLDER						
SOLDERABILITY			SOLDERED AT SOLDER TEMPERATURE, 245°C FOR IN IMMERSION ,DURATION ,10s.							SHALL CO	SHALL COVER MINIMUM OF 95 % OF THE X - SURFACE BEING IMMERSED.					
												2				
REMARKS · DRAWN								DESIGN	IED	CHECKED	APPRO	OVED	RELEA	SED		
NOTI	E1:INCLUD E2:APPLY <sup>*</sup> PRODUC TEMPER	ING THE TEMPERAT TO THE CONDITION CTS BEFORE PCB O	OF LONG T N BOARD, A ITY RANGE	IG TERM STORAGE FOR UNUSED RD, AFTER PCB BOARD, OPERATING NGE IS APPLIED FOR INTERIM				F.N	//atsu		171 / 4					
		erwise specifie			JIS C 5402.					107.05.51 104.03.31						
Note	e QT:Q	ualification Test	AT:Ass	surance	Test	×:Ap <sub>l</sub>	plicable Tes	t		<del></del>	DADT	IO				
H	75	HIROSE EL					ECIFIC	ATI		SHEET	PART N	DF11-*D	S-2D	SA (0	6)	
COL	E NO.(OI -	.D)	DRAWING NO. ELC4-162401-02						ART NO. 1 1 1 1							